



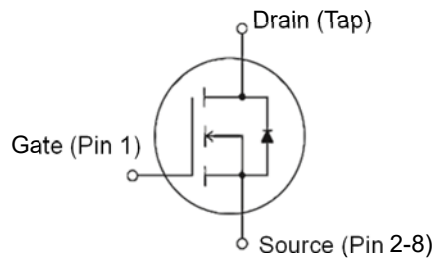
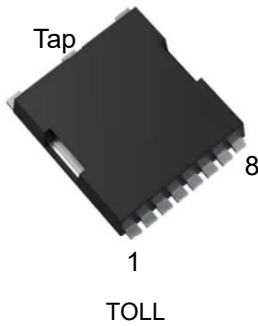
650V N-Channel Power MOSFET

**Product Summary**

Parameter	Value	Unit
$V_{DS} @ T_{jmax}$	650	V
$R_{DS(on),max} @ V_{GS} = 10\text{ V}$	48	mΩ
$I_D @ V_{GS} = 10\text{ V}$	60	A
$P_{tot}$	350	W

**Features**

- \* Low on-resistance
- \* Low switching losses
- \* Excellent FOM
- \* Excellent stability and uniformity



**Application**

- \* PC power
- \* Server power
- \* EV charger
- \* LED lighting
- \* UPS

Maximum ratings $T_A = 25^\circ\text{C}$ unless otherwise noted			
Parameter	Symbol	Limit	Unit
Drain - source voltage	$V_{DS}$	650	V
Continuous drain current	$I_D$	$T_C @ 25^\circ\text{C}$	60
		$T_C @ 100^\circ\text{C}$	35
Pulsed drain current $t_p$ limited by $T_j$ max (Note 1)	$I_D$ pulsed	240	A
Single pulse avalanche energy (Note 2)	$E_{AS}$	900	mJ
Gate-source voltage	$V_{GS}$	$\pm 30$	V
Power dissipation	$P_{tot}$	350	W
Storage temperature range	$T_{STG}$	- 55 to +150	$^\circ\text{C}$
Operating junction temperature range	$T_j$	- 55 to +150	$^\circ\text{C}$



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Electrical characteristics $T_A = 25^\circ\text{C}$ unless otherwise specified						
Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{GS} = 0\text{V}, I_D = 1\text{mA}$	$BV_{DSS}$	650	---	---	V
Gate-source leakage	$V_{GS} = \pm 30\text{V}, V_{DS}=0\text{V}$	$I_{GSS}$	---	---	$\pm 100$	nA
Zero gate voltage drain current	$V_{DS}= 650\text{V}, V_{GS}= 0\text{V}, T_j=25^\circ\text{C}$	$I_{DSS}$	---	---	1	$\mu\text{A}$
<b>On characteristics</b>						
Drain-source on-state resistance	$V_{GS} = 10\text{V}, I_D = 30\text{A}, T_j=25^\circ\text{C}$	$R_{DS(on)}$	---	43	48	$\text{m}\Omega$
Gate-source threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	$V_{GS(th)}$	3	4	5	V
Gate resistance	$f = 1\text{MHz}, \text{open drain}$	$R_G$	---	3.2	---	$\Omega$
<b>Dynamic and switching characteristics-</b>						
Gate-source charge	$V_{DD} = 400\text{V}, I_D = 30\text{A}$ $V_{GS} = 0 \text{ to } 10\text{V}$	$Q_{gs}$	---	35	---	nC
Gate-drain charge		$Q_{gd}$	---	45	---	
Gate charge total		$Q_g$	---	110	---	
Turn-on delay time	$V_{DD} = 400\text{V}, I_D = 30\text{A}$ $V_{GS} = 10\text{V}, R_G = 1.8\Omega$	$t_{d(on)}$	---	15	---	ns
Rise time		$t_r$	---	35	---	
Turn-off delay time		$t_{d(off)}$	---	87	---	
Fall time		$t_f$	---	6	---	
Input capacitance	$V_{GS} = 0\text{V}, V_{DS} = 35\text{V},$ $f = 1\text{MHz}$	$C_{iss}$	---	5300	---	pF
Output capacitance		$C_{oss}$	---	230	---	

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
<b>Drain-source diode characteristics and maximum ratings</b>						
Inverse diode forward voltage	$I_S = 30\text{A}, V_{GS} = 0\text{V}$	$V_{SD}$	---	0.95	1.5	V
Reverse recovery time	$V_R = 400\text{V}, I_F = 30\text{A},$ $di_F / dt = 100\text{A} / \mu\text{S}$	$t_{rr}$	---	180	---	ns
Reverse recovery charge		$Q_{rr}$	---	3	---	$\mu\text{C}$

Notes:

1. Repetitive rating : pulsed width limited by maximum junction temperature.
2.  $V_{DD}=50\text{V}$ , starting  $T_j=25^\circ\text{C}$ .



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Thermal characteristics			
Thermal resistance junction-to-case	R <sub>thJC</sub>	0.36	°C / W
Thermal resistance junction-to-ambient	R <sub>thJA</sub>	40	

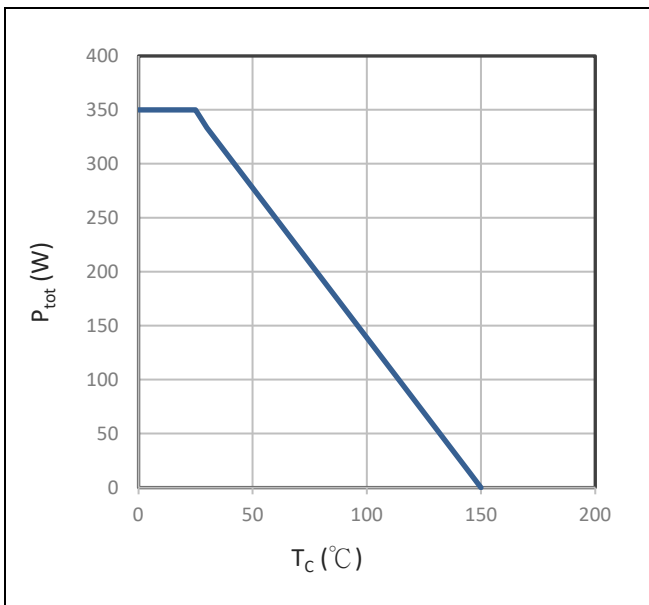
**Package Marking and Ordering Information**

Type / Ordering Code	Package	Packaging	Related Links
I3JL60N65QS	TOLL	Tape& Reel	see Package Outline

**Electrical Characteristics Diagrams**

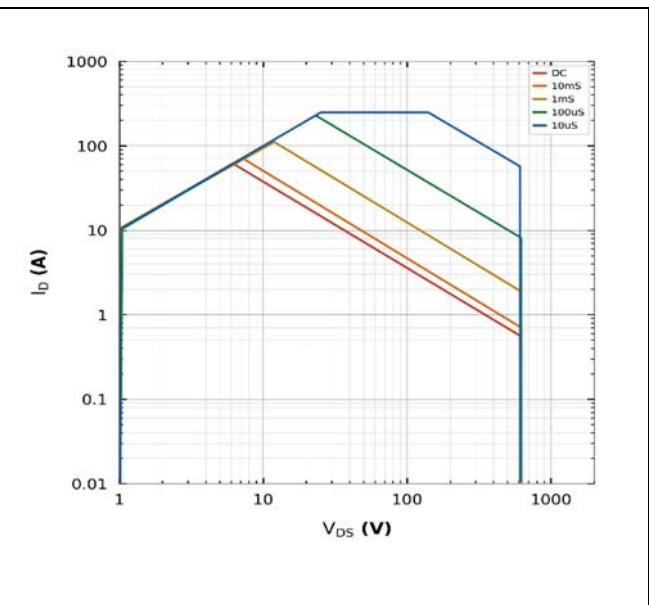
**Fig 1: Power dissipation**

$P_{tot} = f(T_c)$



**Fig 2: Safe operating area**

$I_D = f(V_{DS})$ ; V<sub>GS</sub> > 10V, D = 0, T<sub>c</sub> = 25°C ; parameter : tp





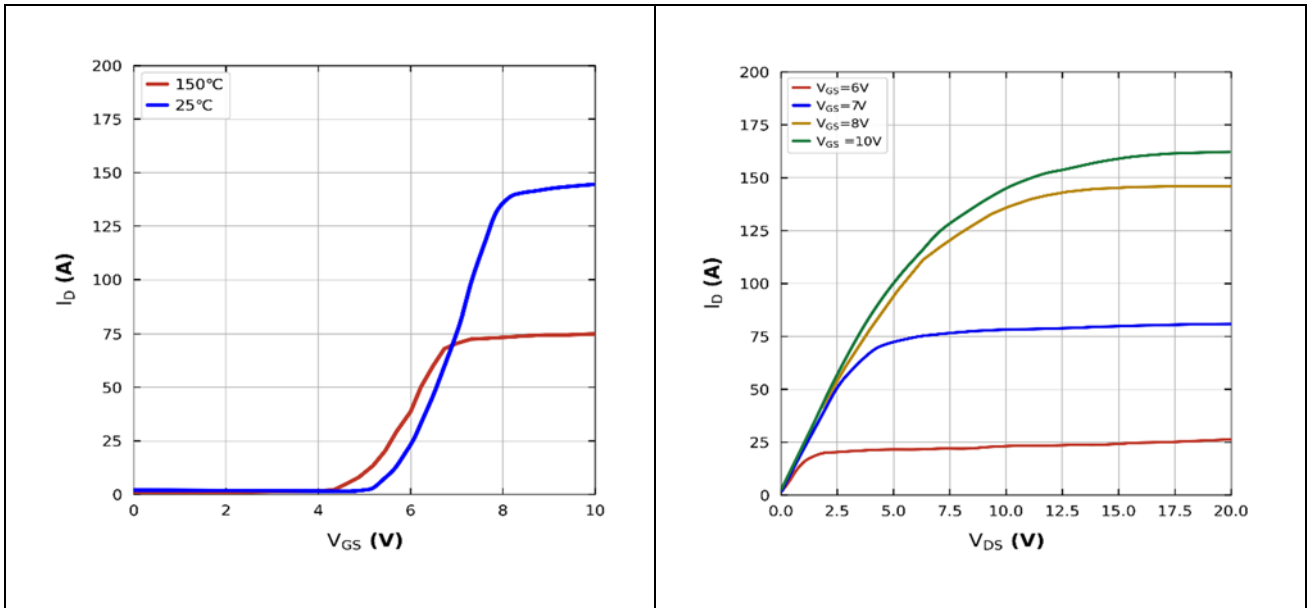
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**Fig 3: Typ. transfer characteristics**

$I_D = f(V_{GS})$ ;  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$ ,  $T_j = 25^\circ\text{C}$

**Fig 4: Typ. output characteristics**

$I_D = f(V_{DS})$ ;  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

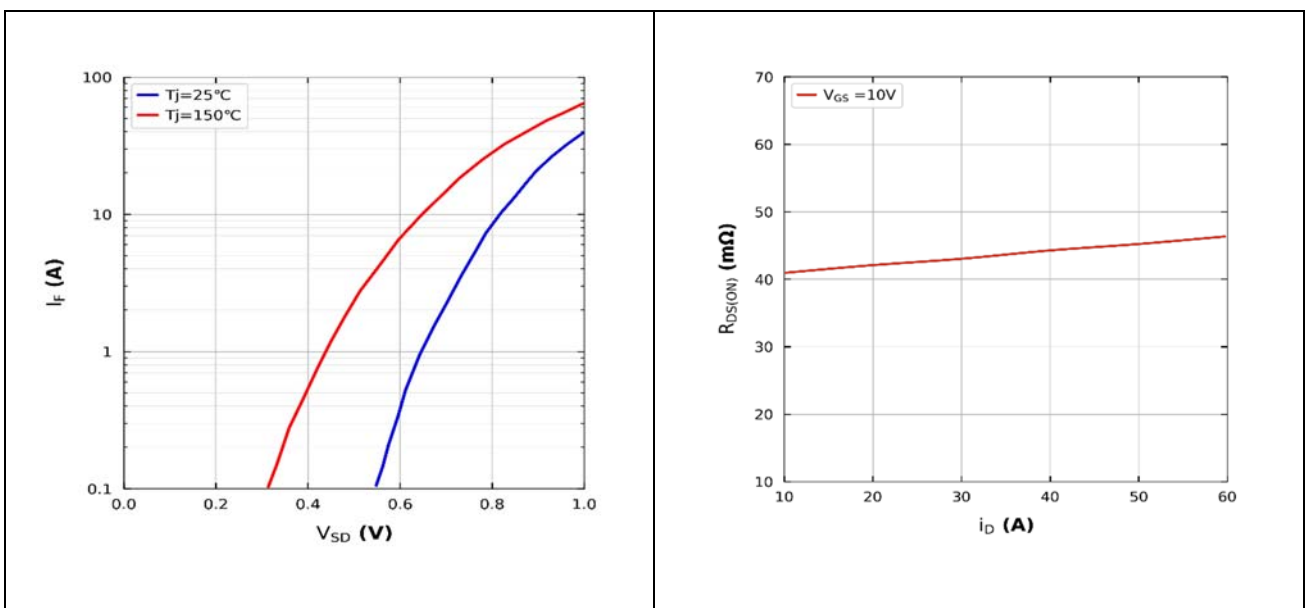


**Fig 5: Forward characteristics of body diode**

$I_F = f(V_{SD})$ ; parameter:  $T_j$

**Fig 6: Typ. drain source on-resistance**

$R_{DS(on)} = f(I_D)$ ;  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

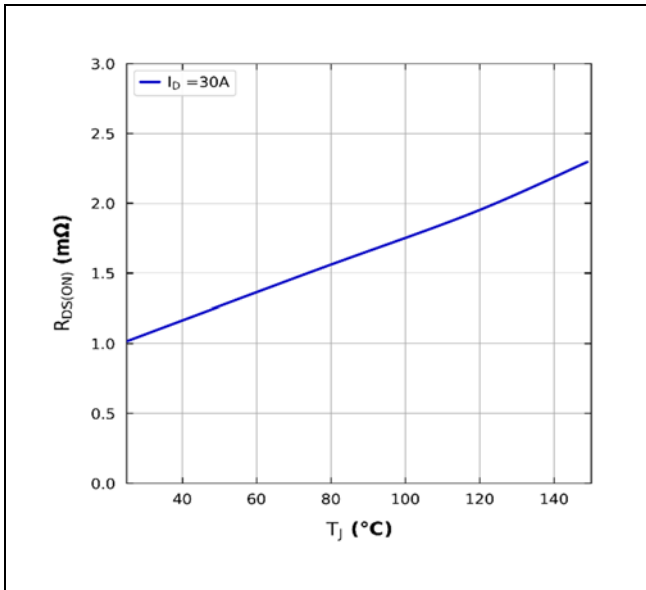




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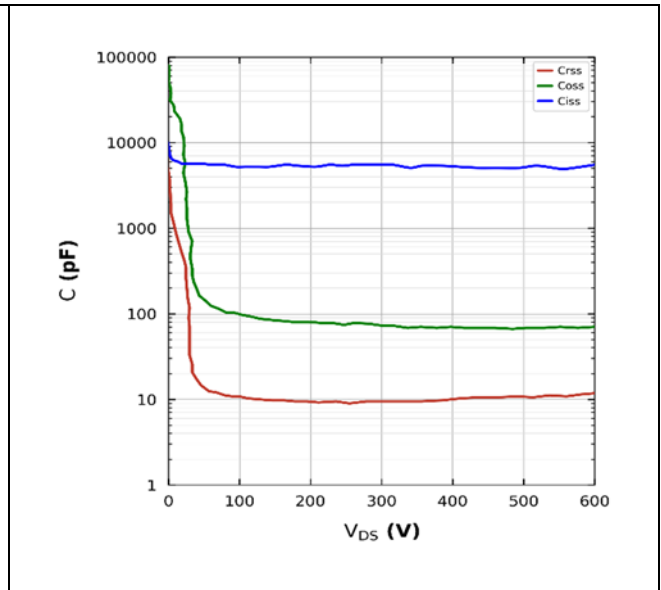
**Fig 7: Drain-source on-state resistance**

$R_{DS(on)} = f(T_j)$ ;  $I_D = 15A$ ,  $V_{GS} = 10V$



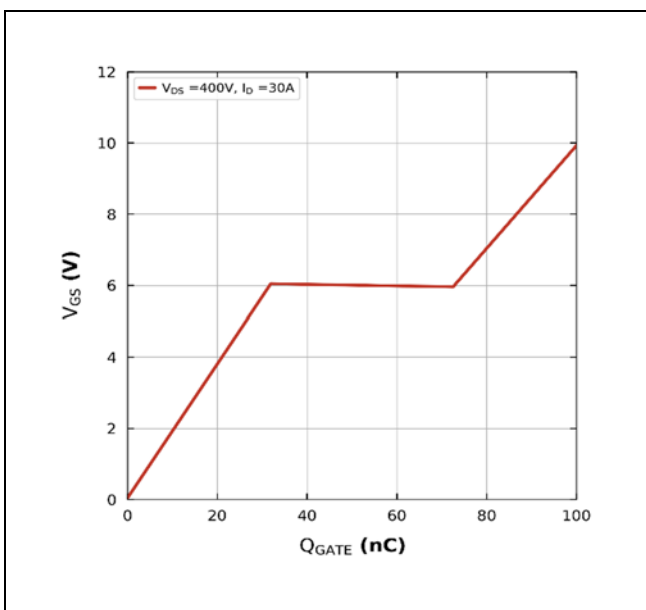
**Fig 8: Typ. capacitances**

$C = f(V_{DS})$ ; parameter:  $V_{GS} = 0V$ ,  $f = 1MHz$



**Fig 9: Typ. gate charge**

$V_{GS} = f(Q_{GATE})$ ;  $I_D = 30A$  pulsed





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**Test Circuit**

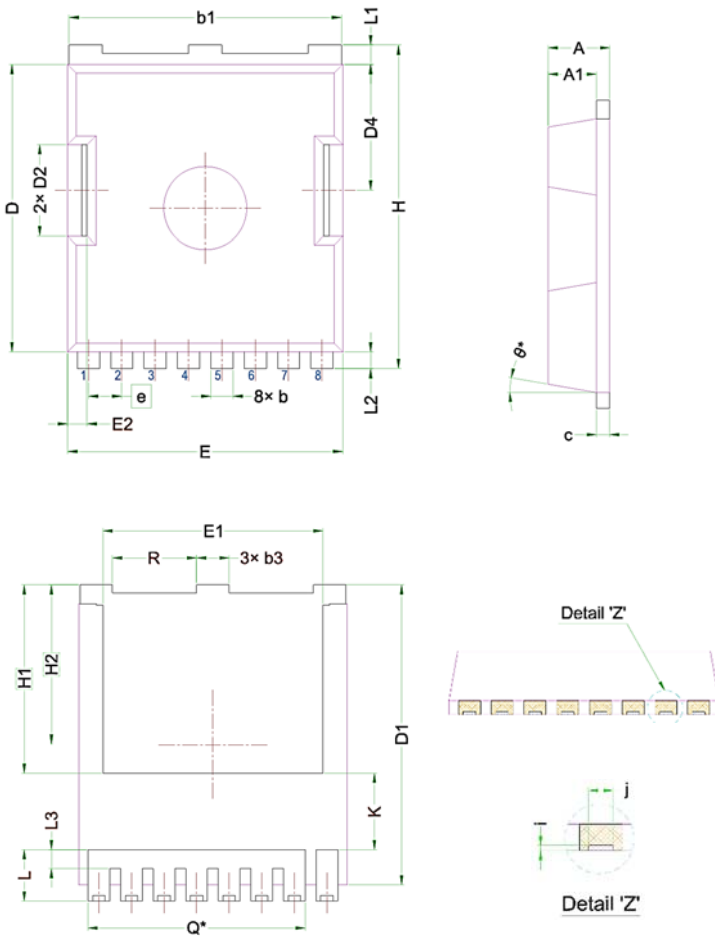
<p><b>Unclamped test circuit</b></p>	<p><b>Unclamped test waveform</b></p>
<p><b>Gate charge test circuit</b></p>	<p><b>Basic gate charge waveform</b></p>
<p><b>Diode recovery test circuit</b></p>	<p><b>Diode recovery test waveform</b></p>
<p><b>Switching test circuit (resistor load)</b></p>	<p><b>Switching test waveform</b></p>



# I3JL60N65QS

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### Package Outline



Ref.	Dimensions		
	Min.	Typ.	Max.
A	2.20	2.30	2.40
A1	1.70	1.80	1.90
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
b3	1.10	1.20	1.30
c	0.40	0.50	0.60
D	10.28	10.38	10.48
D1	10.98	11.08	11.18
D2	3.20	3.30	3.40
D4	4.45	4.55	4.65
E	9.80	9.90	10.00
E1	8.00	8.10	8.20
E2	0.60	0.70	0.80
e	1.20 BSC		
H	11.58	11.68	11.78
H1	6.95 BSC		
H2	5.89 BSC		
i	0.10 REF.		
j	0.46 REF.		
K	2.80 REF.		
L	1.40	1.90	2.10
L1	0.60	0.70	0.80
L2	0.50	0.60	0.70
L3	0.30	0.70	0.80
N	8		
Q	8.00 REF.		
R	3.00	3.10	3.20
theta	10° REF.		